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## Amendments to the Claims

This listing of the claims will replace all prior versions:

## Listing of claims:

1. (Currently Amended) A method of making homogenous LCT-epoxy polymers with HTC-oligomers having a dielectric strength of at least 1.2 kV/mil comprising:

grafting at least one functionalized organic group onto at least one nanosized HTC-material to produce HTC-oligomer product;

reacting said HTC-oligomer product with at least one LCT-epoxy resin under sufficient conditions to form a uniform dispersion and an essentially complete coreactivity of said HTC-oligomer product with said at least one LCT-epoxy resin, wherein a mixture is formed; and

curing said mixture to produce said homogenous LCT-epoxy polymers with HTC-oligomers;

wherein the amount of said HTC-oligomer product to said at least one LCT-epoxy resin comprises a ratio of between 1:4 and 3:1 by weight;

whereby the homogeneous nature of said LCT-epoxy polymers enables the dielectric strength of at least 1.2 kV/mil.

- 2. (Original) The method of claim 1, wherein said at least one nano-sized HTC-material comprises at least one of alumina, silica and a metal oxide.
- 3. (Original) The method of claim 2, wherein said metal oxide is magnesium oxide.
- 4. (Original) The method of claim 1, wherein the grafting said at least one functionalized organic group onto said at least one nano-sized HTC-material is performed by at least one of a silane grafting and a free radical grafting.
- 5. (Original) The method of claim 1, wherein the HTC-oligomer portions of said homogenous LCT-epoxy polymers with HTC-oligomers is 20-50% by weight.

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- 6. (Original) The method of claim 1, wherein reacting said HTC-oligomer product with said at least one LCT-epoxy further comprises warming until said mixture is clear.
- 7. (Original) The method of claim 1, further comprising mixing at least one anhydriding agent with at least one of said at least one LCT-epoxy resin and said HTC-oligomer product, wherein said homogenous LCT-epoxy polymers with HTC-oligomers are a homogenous LCT-epoxy anhydride polymers with HTC-oligomers.
- 8. (Original) The method of claim 7, wherein said anhydriding agent is taken from the group consisting of 1-methylhexahydrophthalic anhydride and 1-methyltetrahydrophthalic anhydride.
- 9. (Original) The method of claim 7, wherein said anhydriding agent is approximately 20-40% by weight of said homogenous LCT-epoxy polymers with HTC-oligomers.
- 10. (Original) The method of claim 1, further comprising mixing at least one vinyl agent with at least one of said at least one LCT-epoxy resin and said HTC-oligomer product, wherein said homogenous LCT-epoxy polymers with HTC-oligomers are a homogenous LCT-epoxy vinyl polymers with HTC-oligomers.
- 11. (Original) The method of claim 10, wherein said vinyl agent is p-vinylphenylglycidylether.
- 12. (Original) The method of claim 10, wherein said vinyl portion is approximately 4-16% by weight of said homogenous LCT-epoxy polymers with HTC-oligomers.
- 13. (Original) The method of claim 1, wherein said mixture is added to an electrical insulator as a coating before curing.
- 14. (Currently Amended) A method of making homogenous LCT-epoxy polymers with HTC-oligomers having a dielectric strength of at least 1.2 kV/mil coated on at least one electrical insulator comprising the steps of:

grafting at least one functionalized organic group onto at least one nanosized HTC-material to produce HTC-oligomer product;

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reacting said HTC-oligomer product with at least one LCT-epoxy resin wherein a mixture is formed;

warming said mixture under sufficient conditions to form a uniform dispersion and an essentially complete co-reactivity of said HTC-oligomer product with said at least one LCT-epoxy resin;

impregnating said mixture onto said electrical insulator; and curing said mixture to produce said homogenous LCT-epoxy polymers with HTC-oligomers;

wherein the amount of said HTC-oligomer product to said at least one LCT-epoxy resin comprises a ratio of between 1:4 and 3:1 by weight;

whereby the homogeneous nature of said LCT-epoxy polymers enables the dielectric strength of at least 1.2 kV/mil.

- 15. (Original) The method of claim 14, further comprising mixing at least one anhydriding agent with at least one of said at least one LCT-epoxy resin and said HTC-oligomer product, wherein said homogenous LCT-epoxy polymers with HTC-oligomers are a homogenous LCT-epoxy anhydride polymers with HTC-oligomers.
- 16. (Original) The method of claim 14, further comprising mixing at least one vinyl agent with at least one of said at least one LCT-epoxy resin and said HTC-oligomer product, wherein said homogenous LCT-epoxy polymers with HTC-oligomers are a homogenous LCT-epoxy vinyl polymers with HTC-oligomers.
- 17. (Original) The method of claim 14, wherein said electrical insulator is a mica/glass insulating tape.
- 18 (Currently Amended) Homogenous LCT-epoxy polymers with HTC-oligomers comprising:

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at least one HTC-oligomer sub-structure containing at least one nano-sized HTC-material grafted thereto;

at least one LCT-epoxy sub-structure;

a thermal conductivity in the transverse direction of at least 0.50 W/mK and in the thickness direction of at least 0.99 W/mK in an environment of 25°C; and

a dielectric strength of at least 1.2 kV/mil;

wherein said HTC-oligomer sub-structure is organically bonded to said LCT-epoxy substructure;

wherein approximately 20-75 % by weight of said homogenous LCT-epoxy polymers with HTC-oligomers is said HTC-oligomer sub-structure; and

wherein said homogenous LCT-epoxy polymers with HTC-oligomers are substantially free of particle wetting and micro-void formation;

whereby the homogeneous nature of said LCT-epoxy polymers enables the dielectric strength of at least 1.2 kV/mil.

- 19. (Original) The method of claim 18, wherein said at least one nano-sized HTC-material comprises at least one of an alumina, a silica and a metal oxide.
- 20. (Original) The method of claim 18, wherein said homogenous LCT-epoxy polymers with HTC-oligomers contain at least one anhydride, and wherein said anhydride portion is approximately 20-40 % by weight of said homogenous LCT-epoxy polymers with HTC-oligomers.
- 21. (Original) The method of claim 18, wherein said homogenous LCT-epoxy polymers with HTC-oligomers contain at least one vinyl, and wherein said vinyl portion is approximately 4-16% by weight of said homogenous LCT-epoxy polymers with HTC-oligomers.
- 22. (Original) The method of claim 18, wherein said homogenous LCT-epoxy polymers with HTC-oligomers are integrally formed with at least one electrical insulator.